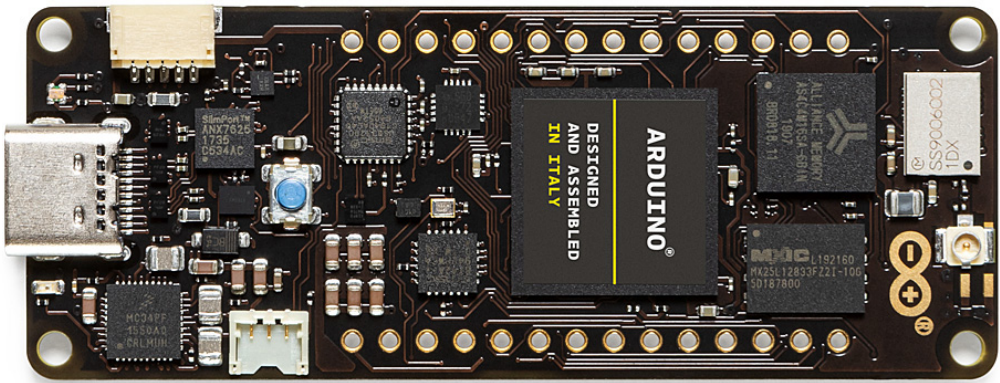


## Description

Portenta H7 family runs high level codes along with real time tasks thanks to the two processors that makes it possible to run tasks in parallel. For example, it is possible to execute Arduino compiled code along with MicroPython one simultaneously, and have both cores to communicate with one another.

## Target Areas:

Laboratory equipment, Computer vision

Name	Portenta H7
SKU	ABX00042
Preview	
Security	<p>ATECC608</p> <p>NXP SE050C2</p>
Connectivity	Ethernet PHY / Wi-Fi® / Bluetooth® Low Energy (BLE 5 via Cordio stack, BLE 4.2 via Arduino Stack)
Memory	8 MB / 16 MB
Power	Li-Po Single Cell 3.7V, 700mAh Minimum

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## 1 Features

Component	Details	
ST STM32H747XI Processor	Dual Core	Arm® Cortex®-M7 core at up to 480 MHz with double-precision FPU and 16K data + 16K instruction L1 cache  Arm® 32-bit Cortex®-M4 core at up to 240 MHz with FPU, Adaptive real-time accelerator (ART Accelerator™)
	Flash Memory	2Mbytes of Flash Memory with read-while-write support  1 Mbyte of RAM
	Dual mode Quad-SPI memory interface running up to 133 MHz	
	CRC calculation unit	
	Security	
	ROP, PC-ROP, active tamper	
	3 separate power domains. Possible to be independently clock gated or switched off.	D1: high performance capabilities  D2: communication peripherals and timers  D3: reset/clock control/power management
	Voltage scaling in Run and Stop mode 6 configurable ranges	
	4 DMA controllers to unload the CPU	
	1x high-speed master direct memory access controller (MDMA) With linked list support	
	2x Dual-port DMA with FIFO	
	1x basic DMA with request router capabilities	

Component	Details	
	Up to 35 communication peripherals	4× I2Cs FM+ interfaces (SMBus/PMBus) 4× USARTs/4x UARTs (ISO7816 interface, LIN, IrDA, up to 12.5 Mbit/s) and 1x LPUART 6× SPIs, 3 with muxed duplex I2S audio class accuracy via internal audio PLL or external clock, 1x I2S in LP domain (up to 150 MHz) 4x SAls (serial audio interface) SPDIFRX interface SWPMI single-wire protocol master I/F MDIO Slave interface 2× SD/SDIO/MMC interfaces (up to 125 MHz) 2× CAN controllers: 2 with CAN FD, 1 with time-triggered CAN (TT-CAN) 2× USB OTG interfaces (1FS, 1HS/FS) crystal-less solution with LPM and BCD Ethernet MAC interface with DMA controller
	8-bit camera interface (up to 80 MHz)	
	11 analog peripherals	
	3x ADCs with 16-bit max. resolution (up to 36 channels, up to 3,6 MSPS)	
	1x temperature sensor	
	2x 12-bit D/A converters (1 MHz)	
	2x ultra-low power comparators	
	2x operational amplifiers (7.3 MHz bandwidth)	
	1x digital filters for sigma delta modulator (DFSDM) with 8 channel/4 filters	
	Graphics	
	Chrom.ART graphical hardware Accelerator™ (DMA2D) to reduce CPU load	
	Hardware JPEG Codec	
	Up to 22 timers and watchdogs	
	1x high-resolution timer (2.1 ns max resolution)	

Component	Details	
	2× 32-bit timers with up to 4 IC/OC/PWM or pulse counter and quadrature (incremental) encoder input (up to 240 MHz)	
	2× 16-bit advanced motor control timers (up to 240 MHz)	
	10× 16-bit general-purpose timers (up to 240 MHz)	
	5× 16-bit low-power timers (up to 240 MHz)	
	4× watchdogs (independent and window)	
	2× SysTick timers	
	RTC with sub-second accuracy and hardware calendar	
	True random number generators (3 oscillators each)	
	96-bit unique ID	
External memories	SDRAM (optional)	Up to 64 MByte
	QSPI Flash (optional)	Up to 128 MByte
USB-C	High speed (optional/FULL Speed USB)	
	Host and Device operation	
	Power Delivery support (optional)	
	DisplayPort	
High Density connectors	1x10/100 Ethernet with PHY	
	1x CAN	
	4x UART (2 with flow control)	
	3x I2C	
	1x SD Card	
	1x SPI	
	1x I2S	
	1x PDM input	
	2 lane MIPI DSI output	
	8 bit parallel camera interface	
	10x PWM output	
	7x GPIO	
	8x ADC inputs with separate VREF	
ATECC608 Microchip Crypto (optional)	Protected storage for up to 16 Keys, certificates or data	
	Hardware support for asymmetric sign, verify, key agreement – ECDSA: FIPS186-3 Elliptic Curve Digital Signature	

Component	Details	
	ECDH: FIPS SP800-56A Elliptic Curve Diffie-Hellman	
	NIST standard P256 elliptic curve support	
	Hardware support for symmetric algorithms	
	SHA-256 & HMAC hash including off-chip context save/restore	
	AES-128: encrypt/decrypt, galois field multiply for GCM	
	Networking key management support	
	Turnkey PRF/HKDF calculation for TLS 1.2 & 1.3	
	Ephemeral key generation and key agreement in SRAM - Small message encryption with keys entirely protected	
	Secure boot support	
	Full ECDSA code signature validation, optional stored digest/signature - optional communication key disablement prior to secure boot	
	Internal high-quality FIPS 800-90 A/B/C Random Number Generator (RNG)	
	Two high-endurance monotonic counters	
	Guaranteed unique 72-bit serial number	
SE050C2 Secure element	Ready-to-use IoT secure element solution	
	Securely storing and provisioning credentials and performing cryptographic operations	
	based on NXP's Integral Security Architecture 3.0™	
	CC EAL 6+ certified HW	
	FIPS 140-2 certified platform with Security Level 3	
	Support for RSA and ECC asymmetric cryptography algorithms	
	Support for SCP03 protocol	

Component	Details	
	up to 100 Mio write cycles / 25 years	
MKR compatible header	7x PWM channels	
	7x ADC channels	
	1x SPI	
	1x UART	
	1x I2C	
ESLOV Connector	I2C port with automatic device enumeration	
NXP PF1550 Programmable PMIC	Dynamic voltage scaling	
	Programmable independent	
	1A voltage output to carrier board	
	Programmable I/O voltage	
	Integrated Li-Po/Li-Ion Battery charger	

## 2 Ratings

### 2.1 Recommended Operating Conditions

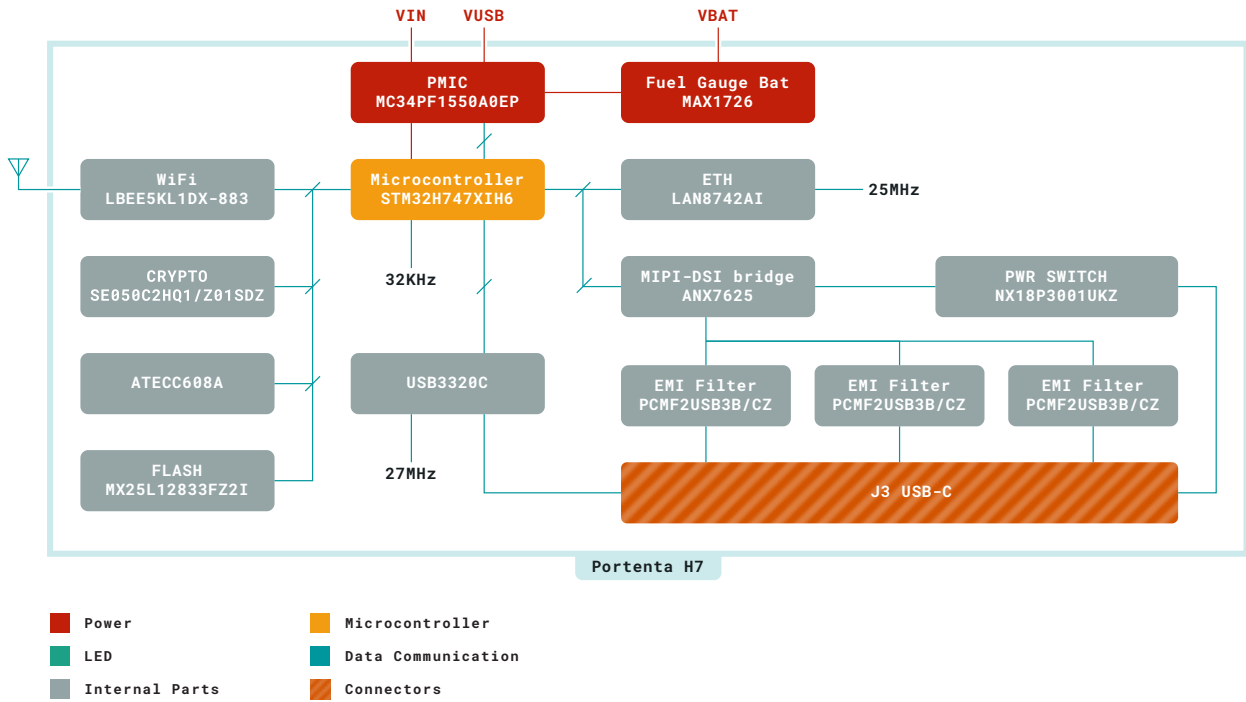
Symbol	Description	Min	Max
	Conservative thermal limits for the whole board:	-40 °C (-40 °F)	85 °C (185 °F)

### 2.2 Power Consumption

Symbol	Description	Min	Typ	Max	Unit
VINMax	Maximum input voltage from VIN pad	-0.3	-	xx	V
VUSBMax	Maximum input voltage from USB connector	-0.3	-	xx	V
PMax	Maximum Power Consumption	-xx	-	xx	mW

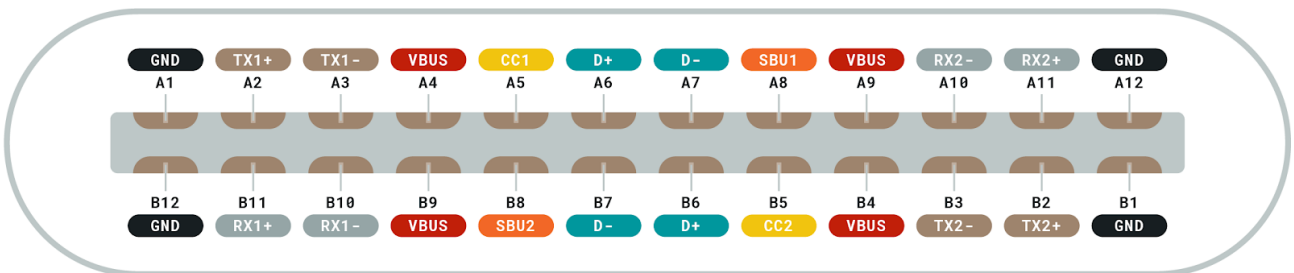


### 2.3 Block Diagram



Block diagram

### 3 Connector Pinouts



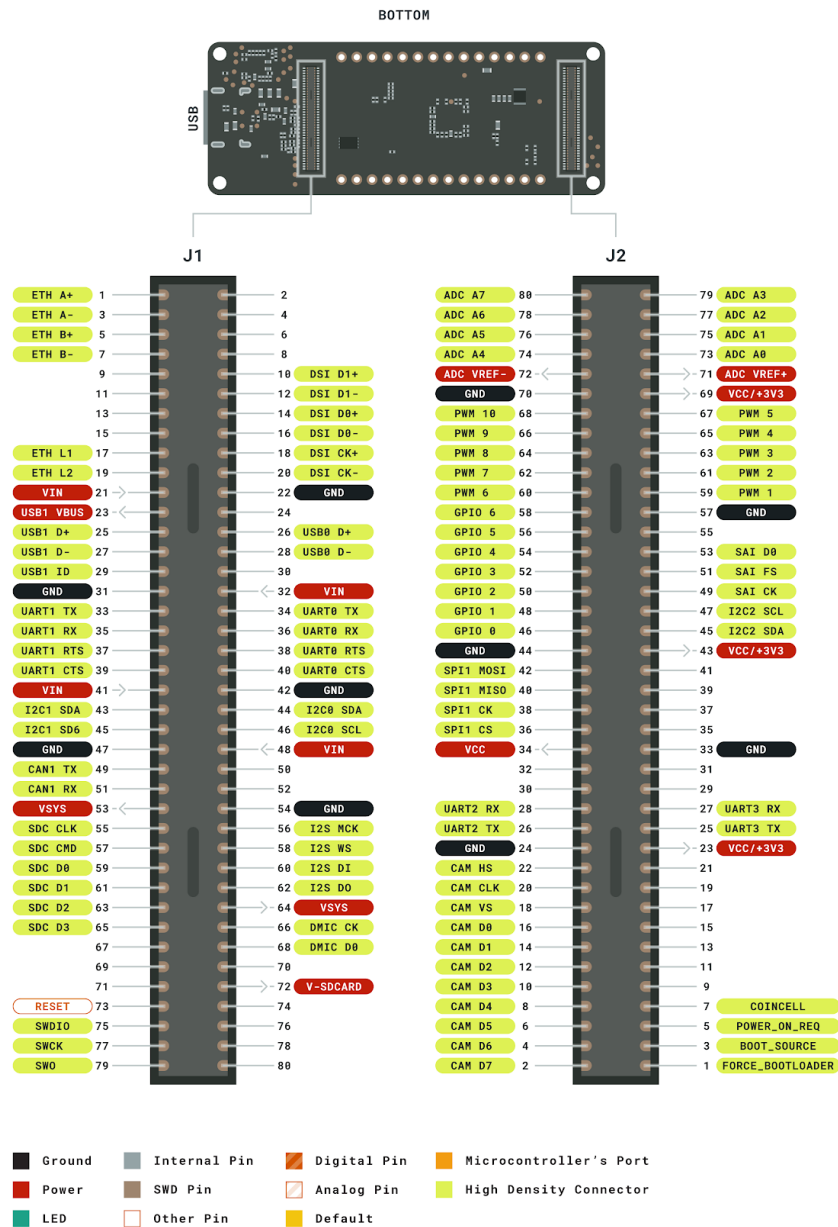
- Cable ground
- Cable bus power
- USB 2.0 Interface
- High speed data path (TX for USB, or RX for DP Alt Mode)
- High speed data path (RX for USB, or TX for DP Alt Mode)
- For sideband use (Not used for USB)
- Plug configuration detection
  - One becomes VCONN, for cable or adaptor power
  - CC is used for USB-PD communication

USB-C Pinout

### 3.1 USB-C

Pin	Description	Pin	Description
GND	Cable Ground	TX1 +/- TX2 +/-	High speed data path (TX for USB, or RX for DP Alt Mode)
VBUS	Cable bus power	RX1 +/- RX2 +/-	High speed data path (TX for USB, or RX for DP Alt Mode)
D+/D-	USB 2.0 Interface	SBU1 SBU2	For sideband use (Not used for USB)
CC1 CC2	Plug configuration detection * One becomes VCONN for cable or adaptor power * CC is used for USB-PD communication		

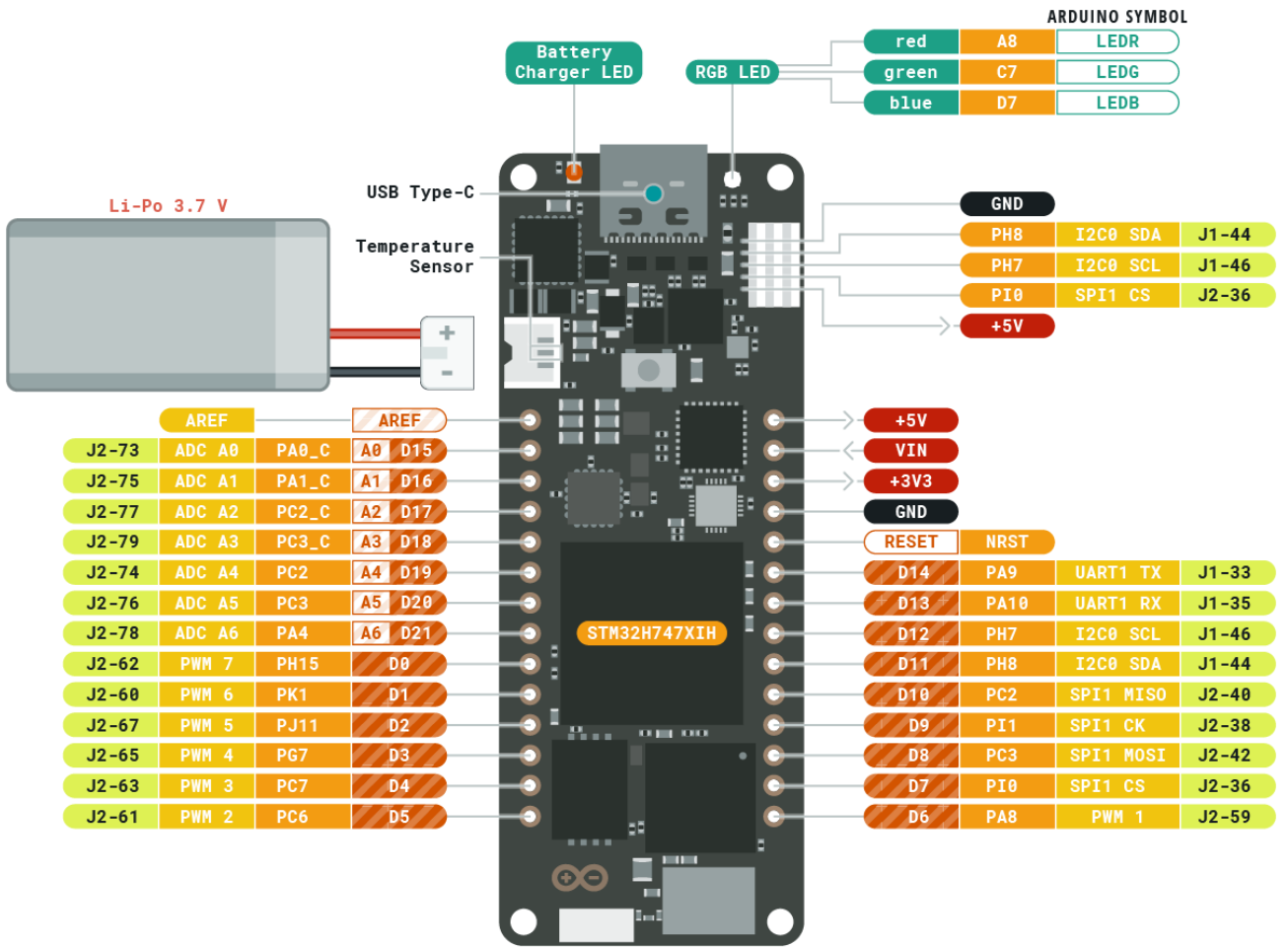
### 3.2 High Density Connector



High density connectors pinouts

Pin	Description	Pin	Description
ETH	High Density Connector	CAN	High Density Connector
USB	High Density Connector	DSI	High Density Connector
CAM	High Density Connector	DMIC	High Density Connector
I2C0 I2C1 I2C2I2S	High Density Connector	VSYS VIN V-SDCARDVCC VBUS USB ADC-VREF	Power
GND	Ground	PWM	High Density Connector
GPIO	High Density Connector	SPI1	High Density Connector
SWDIOSWCK SWO	High Density Connector	ADC	High Density Connector
SDC	High Density Connector	RESET	Other Pin

### 3.3 Wake Up Signals/External Relay Commands



- Ground
- Internal Pin
- Digital Pin
- Microcontroller's Port
- Power
- SWD Pin
- Analog Pin
- High Density Connector
- LED
- Other Pin
- Default

MKR format Headers pinout

## 4 Application Examples

Due to the dual core processing, the Portenta supports a wide array of applications.

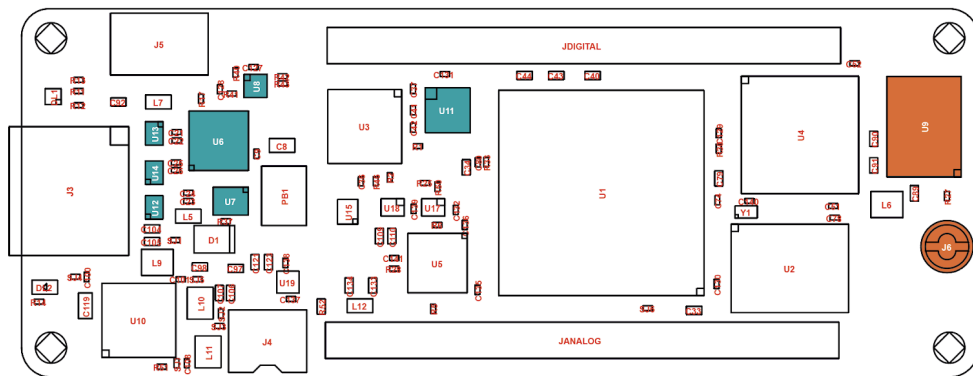
### 4.1 Accessories

- Portenta Vision shield
- USB 2.0 Cable Type A/B
- Portenta Breakout Board

## 5 Functional Overview

### 5.1 Board Topology

Depending on the variant, some of the components does not apply. The image below originates from the H7 form factor, see what components are applied on your board:



Only with Portenta H7



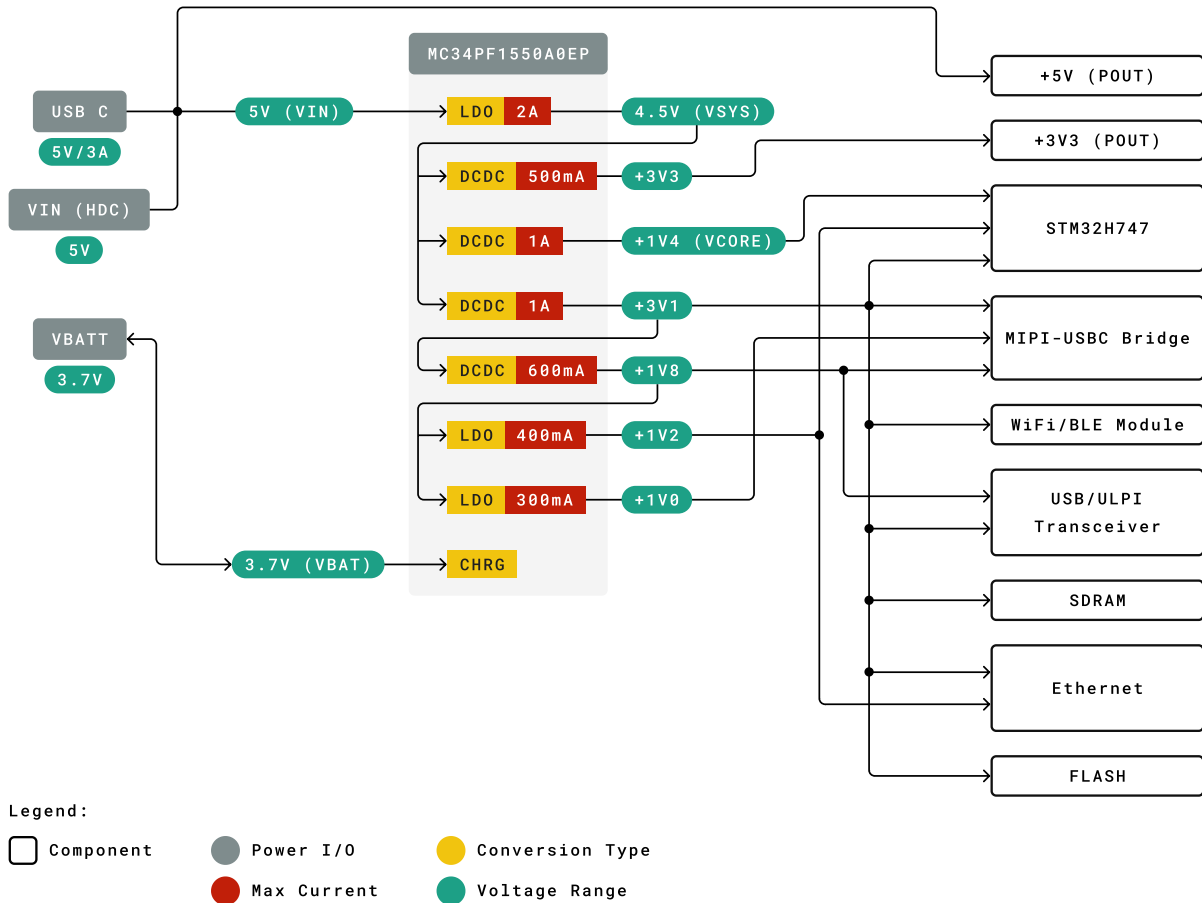
Only with Portenta H7 and Portenta H7 Lite Connected

Board Topology

Ref.	Description	Ref.	Description
U1	Main processor	U10	Power Manager
U2	QSPI Flash Memory	U11	Crypto Chip (NXP)
U3	USB HS PHY	U12, U13, U14	ESD protection
U4	SDRAM	U16	Crypto Chip (Microchip)
U5	Ethernet PHY	J1, J2	High Density Connectors
U6	MIPI to USB-C/DisplayPort converter	ANT1	Antenna or U.FL Connector
U7	Level Shifter	JANALOG JDIGITAL	MKR Compatible headers
U8	I2C level shifter	J4	Battery Connector

Ref.	Description	Ref.	Description
U9	Wifi/BT Module	J5	ESLOV Connector
J6	Connector micro UFL		

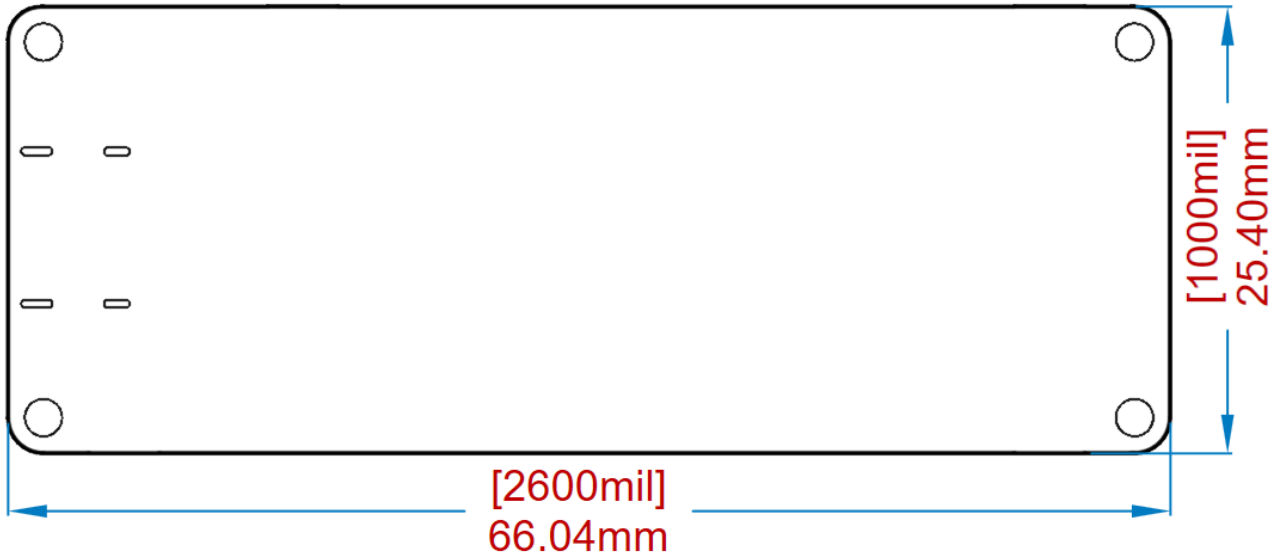
### 5.2 Power Tree



Portenta H7 Power Tree

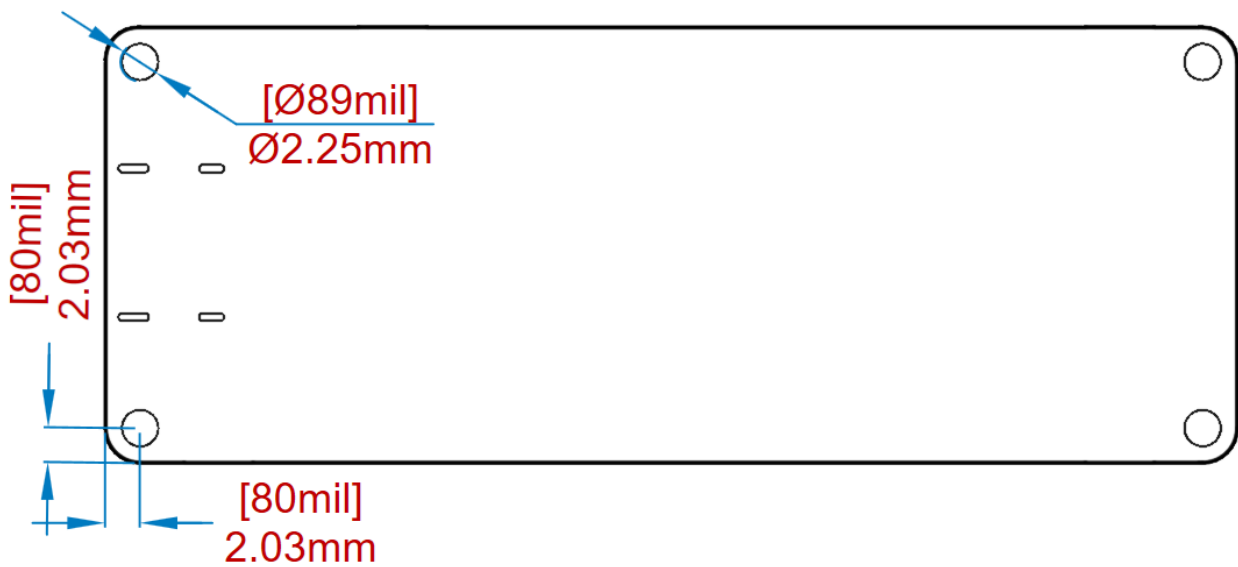
## 6 Mechanical Information

### 6.1 Board Outline



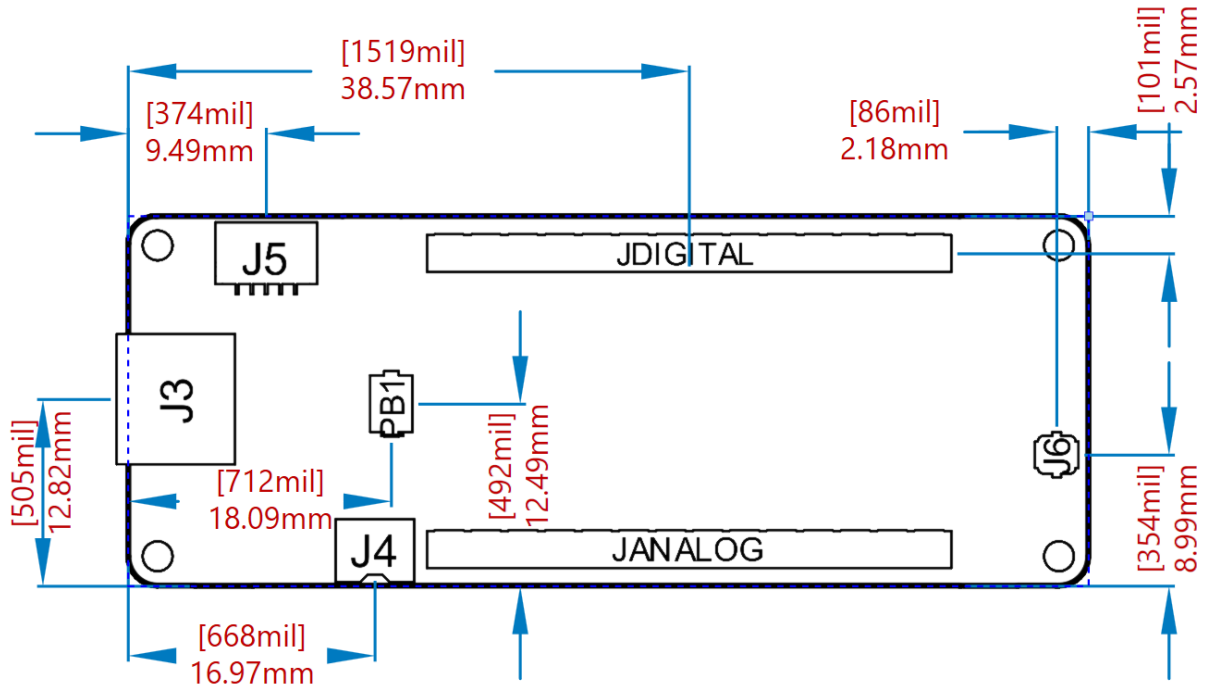
Board outline

### 6.2 Mounting Holes

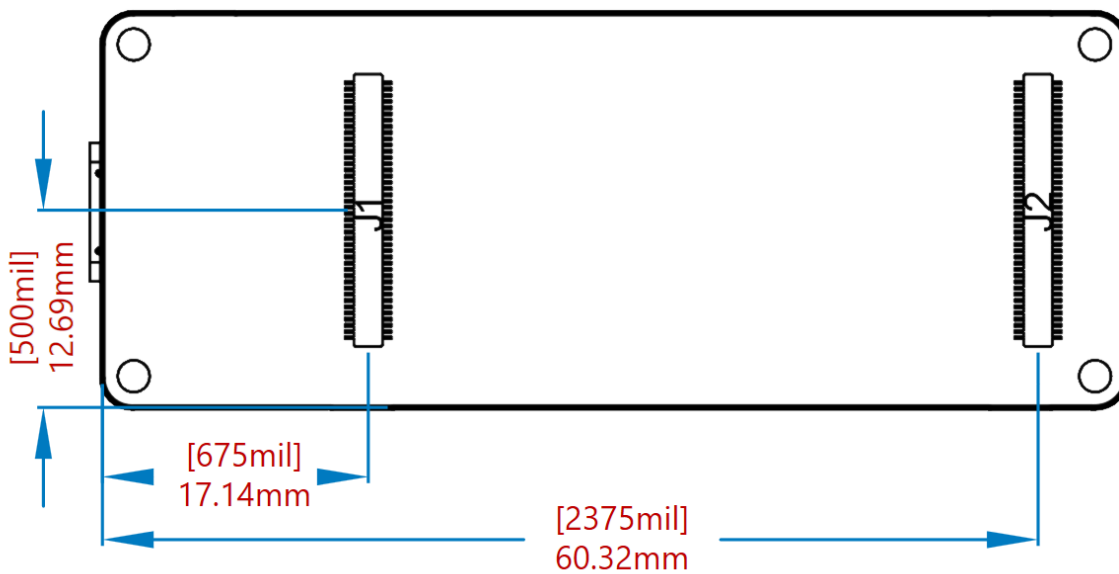


Mounting outline

6.3 Connector Positions



Connectors positions top



Connectors positions bottom



## 7 Certifications

Certification	Details
<b>CE (EU)</b>	EN 301489-1, EN 301489-17, EN 300328, EN 62368-1, EN 62311
<b>WEEE (EU)</b>	Yes
<b>RoHS (EU)</b>	2011/65/(EU) 2015/863/(EU)
<b>REACH (EU)</b>	Yes
<b>UKCA (UK)</b>	Yes
<b>RCM (RCM)</b>	Yes
<b>FCC (US)</b>	<b>ID.</b> Radio: Part 15-247 MPE: Part 2. 1091
<b>IC (CA)</b>	<b>ID.</b> Radio: RSS-247 MPE: RSS-102
<b>RCM (AU)</b>	Yes
<b>SRRC (China) NO</b>	X
<b>MIC (Japan)</b>	Article 2, Paragraph 1, Item 19

### 7.1 Declaration of Conformity CE DoC (EU)

We declare under our sole responsibility that the products above are in conformity with the essential requirements of the following EU Directives and therefore qualify for free movement within markets comprising the European Union (EU) and European Economic Area (EEA).

### 7.2 Declaration of Conformity to EU RoHS & REACH 211 01/19/2021

Arduino boards are in compliance with RoHS 2 Directive 2011/65/EU of the European Parliament and RoHS 3 Directive 2015/863/EU of the Council of 4 June 2015 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Substance	Maximum limit (ppm)
Lead (Pb)	1000
Cadmium (Cd)	100
Mercury (Hg)	1000
Hexavalent Chromium (Cr6+)	1000
Poly Brominated Biphenyls (PBB)	1000
Poly Brominated Diphenyl ethers (PBDE)	1000
Bis(2-Ethylhexyl} phthalate (DEHP)	1000
Benzyl butyl phthalate (BBP)	1000
Dibutyl phthalate (DBP)	1000
Diisobutyl phthalate (DIBP)	1000

Exemptions : No exemptions are claimed.

Arduino Boards are fully compliant with the related requirements of European Union Regulation (EC) 1907 /2006 concerning the Registration, Evaluation, Authorization and Restriction of Chemicals (REACH). We declare none of the SVHCs (<https://echa.europa.eu/web/guest/candidate-list-table>), the Candidate List of Substances of Very High Concern for authorization currently released by ECHA, is present in all products (and also package) in quantities totaling in a concentration equal or above 0.1%. To the best of our knowledge, we also declare that our products do not contain any of the substances listed on the "Authorization List" (Annex XIV of the REACH regulations) and Substances of Very High Concern (SVHC) in any significant amounts as specified by the Annex XVII of Candidate list published by ECHA (European Chemical Agency) 1907 /2006/EC.

### 7.3 Conflict Minerals Declaration

As a global supplier of electronic and electrical components, Arduino is aware of our obligations with regards to laws and regulations regarding Conflict Minerals, specifically the Dodd-Frank Wall Street Reform and Consumer Protection Act, Section 1502. Arduino does not directly source or process conflict minerals such as Tin, Tantalum, Tungsten, or Gold. Conflict minerals are contained in our products in the form of solder, or as a component in metal alloys. As part of our reasonable due diligence Arduino has contacted component suppliers within our supply chain to verify their continued compliance with the regulations. Based on the information received thus far we declare that our products contain Conflict Minerals sourced from conflict-free areas.

## 8 FCC Caution

Any Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference
- (2) this device must accept any interference received, including interference that may cause undesired operation.

#### **FCC RF Radiation Exposure Statement:**

1. This Transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.
2. This equipment complies with RF radiation exposure limits set forth for an uncontrolled environment.
3. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

Note: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help

English: User manuals for licence-exempt radio apparatus shall contain the following or equivalent notice in a conspicuous location in the user manual or alternatively on the device or both. This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions:

- (1) this device may not cause interference
- (2) this device must accept any interference, including interference that may cause undesired operation of the device.

French: Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes :

- (1) l'appareil n' doit pas produire de brouillage
- (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

**IC SAR Warning:**

English This equipment should be installed and operated with minimum distance 20 cm between the radiator and your body.

French: Lors de l' installation et de l' exploitation de ce dispositif, la distance entre le radiateur et le corps est d'au moins 20 cm.

Radio apparatus containing digital circuitry which can function separately from the operation of a transmitter or an associated transmitter, shall comply with ICES-003. In such cases, the labelling requirements of the applicable RSS apply, rather than the labelling requirements in ICES-003. This Class B digital apparatus complies with Canadian ICES-003.

Cet appareil numérique de la classe B est conforme à la norme NMB-003 du Canada.

This radio transmitter [IC:26792-ABX00042] has been approved by Innovation, Science and Economic Development Canada to operate with the antenna types listed below, with the maximum permissible gain indicated. Antenna types not included in this list that have a gain greater than the maximum gain indicated for any type listed are strictly prohibited for use with this device.

Antenna Manufacturer	Molex
Antenna Model	WiFi 6E Flex Cabled Side-fed Antenna (Series 206994)
Antenna type	External omnidirectional dipole antenna
Antenna gain:	3.6dBi

**Important:** The operating temperature of the EUT can't exceed 85°C and shouldn't be lower than -40°C.

Hereby, Arduino S.r.l. declares that this product is in compliance with essential requirements and other relevant provisions of Directive 2014/53/EU. This product is allowed to be used in all EU member states.

Frequency bands	Maximum output power (EIRP)
2412-2472 MHz(2.4G WIFI)	17.95dBm
2402-2480 MHz(EDR)	2.52 dBm
2402-2480 MHz(BLE)	8.95 dBm

## 9 Company Information

<b>Company name</b>	<b>Arduino S.r.l.</b>
Company Address	Via Andrea Appiani, 25 - 20900 MONZA (Italy)

## 10 Reference Documentation

Reference	Link
Arduino IDE (Desktop)	<a href="https://www.arduino.cc/en/Main/Software">https://www.arduino.cc/en/Main/Software</a>

## 11 Revision History

Date	Revision	Changes
27/12/2021	1	First Release
18/08/2022	2	Add Secure Element specs (SE050C2)